- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

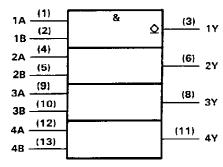
These devices contain four independent 2-input AND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN5409, SN54LS09, and SN54S09 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7409, SN74LS09, and SN74S09 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Y
н	Н	Н
L	Х	L
Х	L	L

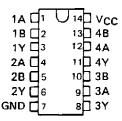
logic symbol



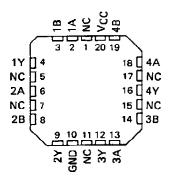
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5409, SN54LS09, SN54S09... J OR W PACKAGE SN7409... N PACKAGE SN74LS09, SN74S09... D OR N PACKAGE (TOP VIEW)

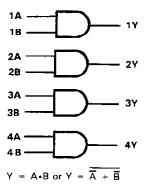


SN54LS09, SN54S09 . . . FK PACKAGE (TOP VIEW)

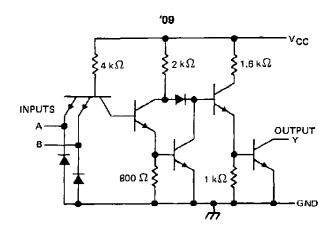


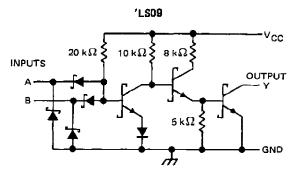
NC-No internal connection

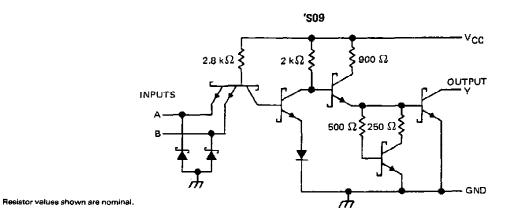
logic diagram (positive logic)



schematics (each gate)







absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage: '09, 'S09		5.5 V
'LS09	· · · · · · · · · · · · · · · · · · ·	7 V
Operating free-air temperature range:	SN54'	–55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		–65°C to 150°C

NOTE 1; Voltage values are with respect to network ground terminal.

SN5409, SN7409 QUADRUPLE 2 INPUT POSITIVE AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

	} :	SN5409			SN740	9	דומט -
	MIN	NOM	MAX	MIN	NOM	MAX	UNII
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			8.0	٧
V _{OH} High-level output voltage			5.5			5.5	٧
IOL Low-level output current			16			16	mΑ
TA Operating free-air temperature	- 55	-	125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN TYP\$ MAX	UNIT
VIK	VCC = MIN,	I _I = - 12 mA	- 1,5	V
(он	V _{CC} - MIN,	V _{1H} = 2 V, V _{OH} = 5,5 V	0.25	mA
VOL	V _{CC} = MIN,	V _{IL} = 0.8 V I _{OL} = 16 mA	0.2 0.4	٧
lj.	VCC = MAX,	V _j = 5.5 V	1	mΑ
Чн	V _{CC} = MAX,	V ₁ = 2.4 V	40	μД
liL.	V _{CC} = MAX,	V ₁ = 0.4 V	- 1.6	mA
ГССН	V _{CC} = MAX,	V ₁ = 4.5 V	11 21	mА
ICCL	V _{CC} = MAX,	V _I = 0 V	20 33	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	тҮР	MAX	UNIT
^t P L H			0.45.5		21	32	ns
t P HL	A or B	Υ	$H_L = 400 \Omega$, $C_L = 15 pF$		16	24	пѕ

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS09, SN74LS09 QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

] ;	SN54LS09			SN74LS09		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			8.0	V
VOH High-level output voltage			5.5			5.5	٧
IOL Low-level output current			4			8	mΑ
Тд Operating free-air temperature	- 55		125	0	•	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

******		TEST CONDITIONS †			SN54LS	09	SN74LS09			
PARAMETER		TEST CONDI	110145 [MIN	TYP‡	MAX	MIN	TYP\$	MAX	UNIT
VIK	V _{CC} = MIN,	lı = — 18 mA				- 1.5			- 1.5	V
юн	V _{CC} = MIN,	V _{IH} = 2 V,	V _{OH} = 5.5 V			0.1			0.1	mΑ
	V _{CC} = MIN,	V _{IL} = MAX,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	VCC = MIN,	VIL = MAX,	I _{OL} = 8 mA				· · · · · · · · · · · · · · · · · · ·	0.35	0.5	"
11	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
ЧН	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μΑ
IIL.	V _{CC} = MAX,	V ₁ = 0.4 V	· · · · · · · · · · · · · · · · · · ·			- 0.4	***		- 0.4	mA
Іссн	V _{CC} = MAX,	V ₁ = 4.5 V			2.4	4.8		2.4	4.8	mA
CCL	V _{CC} = MAX,	V = 0 V	-		4,4	8.8		4.4	8.8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO {QUTPUT}	TEST CON	NDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	A or B	v	$R_1 = 2 k\Omega$,	C _f = 15 pF		20	35	ns
₹PHL	7, 0, 5	,	11[- 2 838,	OE - 19 bi		17	35	กร

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

SN54S09, SN74S09 QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN54S09			SN74S09		
	MIN NO	NOM	MAX	MIN	NOM	MAX	TINU
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{1H} High-level input voltage	2			2			٧
V _{IL} Low-level input voltage			0.8			0.8	v
VOH High-level output voltage			5.5	_		5.5	٧
IOL Low-level output current			20			20	mA
TA Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	MIN TYP# MAX	TINU
ViK	V _{CC} = MIN,	i ₁ = - 18 mA	-1.2	V
ГОН	VCC = MIN,	V _{IH} = 2 V, V _{OH} = 5.5 V	0.25	mA
Vol	V _{CC} = MIN,	V _{IL} = 0.8 V, I _{OL} = 20 mA	0.5	V
lj.	V _{CC} = MAX,	V ₁ = 5.5 V	1	mA
¹ ін	V _{CC} = MAX,	V _I = 2,7 V	50	μА
li L	V _{CC} = MAX,	V _I = 0.5 V	-2	mA
1 _{ССН}	V _{CC} = MAX,	V ₁ = 4.5 V	18 32	mA
ICCL	V _{CC} = MAX,	V _I = 0 V	32 57	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN TYP	MAX	UNIT
[‡] PLH			R _L = 280 Ω,	C _I = 15 pF	6.5	10	ns
tPHL.	A or B			C[- 19pr	6.5	10	ns
tPLH	AUrb	[0 . 50 . 5	9		ns
^t PHL			RL = 280 Ω, —	C _L = 50 pF	9		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
80019012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK
8001901CA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J
8001901CA	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J
8001901DA	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
8001901DA	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
SN54LS09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS09J
SN54LS09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS09J
SN54LS09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS09J
SN54LS09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS09J
SN54S09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S09J
SN54S09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S09J
SN54S09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S09J
SN54S09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54S09J
SN74LS09D	Obsolete	Production	SOIC (D) 14	-	-	Call TI	Call TI	0 to 70	LS09
SN74LS09D	Obsolete	Production	SOIC (D) 14	-	-	Call TI	Call TI	0 to 70	LS09
SN74LS09DR	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DR	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DR.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DR.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DR.B	Active	Production	SOIC (D) 14	2500 LARGE T&R	-	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DR.B	Active	Production	SOIC (D) 14	2500 LARGE T&R	-	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DRE4	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09DRE4	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS09
SN74LS09N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS09N
SN74LS09N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS09N





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Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74LS09N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS09N
SN74LS09N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS09N
SN74LS09NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09
SN74LS09NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09
SN74LS09NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09
SN74LS09NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS09
SN74S09N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S09N
SN74S09N	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S09N
SN74S09N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S09N
SN74S09N.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74S09N
SN74S09NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74\$09
SN74S09NSR	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74\$09
SN74S09NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74\$09
SN74S09NSR.A	Active	Production	SOP (NS) 14	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74S09
SNJ54LS09FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK
SNJ54LS09FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK
SNJ54LS09FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK
SNJ54LS09FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	80019012A SNJ54LS 09FK
SNJ54LS09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J
SNJ54LS09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	SNPB N/A for Pkg Type		8001901CA SNJ54LS09J
SNJ54LS09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J
SNJ54LS09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901CA SNJ54LS09J



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Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SNJ54LS09W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
SNJ54LS09W	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
SNJ54LS09W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
SNJ54LS09W.A	Active	Production	CFP (W) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8001901DA SNJ54LS09W
SNJ54S09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S09J
SNJ54S09J	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S09J
SNJ54S09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S09J
SNJ54S09J.A	Active	Production	CDIP (J) 14	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54S09J

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS09, SN54S09, SN74LS09, SN74S09:

Catalog: SN74LS09, SN74S09

Military: SN54LS09, SN54S09

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS09DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS09NSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74S09NSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS09DR	SOIC	D	14	2500	353.0	353.0	32.0
SN74LS09NSR	SOP	NS	14	2000	353.0	353.0	32.0
SN74S09NSR	SOP	NS	14	2000	353.0	353.0	32.0



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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
80019012A	FK	LCCC	20	55	506.98	12.06	2030	NA
8001901DA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS09N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS09N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74S09N.A	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS09FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS09FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS09W	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54LS09W.A	W	CFP	14	25	506.98	26.16	6220	NA



SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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